

Silicon PNP Planar RF Transistor in bare die form

Description

PNP transistor in unencapsulated chip form. It is primarily intended for use in RF wideband amplifiers, such as in aerial amplifiers, radar systems, oscilloscopes, spectrum analyzers, etc. The transistor features low intermodulation distortion and high power gain; due to its very high transition frequency, it also has excellent wideband properties and low noise up to high frequencies. NPN complements are BFR92 and BFR92A.

Ordering Information

The following part suffixes apply:

- No suffix MIL-STD-883 /2010B Visual Inspection
- "H" MIL-STD-883 /2010B Visual Inspection + MIL-STD-38534 Class H LAT
- "K" MIL-STD-883 /2010A Visual Inspection (Space) + MIL-STD-38534 Class K LAT

LAT = Lot Acceptance Test.

For more information on Hi-Rel LAT flows please see below.

www.siliconsupplies.com/bare die lot qualification

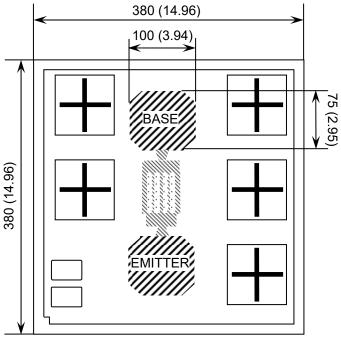
Supply Formats:

- Default Die in Waffle Pack (400 per tray capacity)
- Sawn Wafer on Tape By specific request
- Unsawn Wafer By specific request
- With additional electrical selection Specific request
- Sawn as pairs or adjacent pair pick Specific request

Features:

- High Power Gain
- Low Noise
- Wide Transition Frequency

Die Dimensions in µm (mils)



CHIP BACK IS COLLECTOR

Mechanical Specification

Die Size (Unsawn)	380 x 380 14.96 x 14.96	µm mils
Minimum Bond Pad Size	100 x 75 3.94 x 2.95	μm mils
Die Thickness	280 (±10) 11 (±0.4)	µm mils
Top Metal Composition	Au	
Back Metal Composition	Au	



Rev 1.2

23/11/17



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Absolute Maximum Ratings	T _A = 25°C unless otherwise stated
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SYMBOL	PARAMETER	CONDITIONS	MIN	MAX	UNIT
V _{CBO}	collector-base voltage	open emitter	-	-20	V
V _{CEO}	collector-emitter voltage	open base	-	-15	V
V _{EBO}	emitter-base voltage	open collector	-	-2	V
Ι _C	DC collector current	-	-	-25	mA
P _{tot}	total power dissipation	-	-	200	mW
T _{stg}	storage temperature	-	-65	150	°C
TJ	junction temperature	-	-	175	°C

Electrical Characteristics T_A = 25°C

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
I _{CBO}	collector cut-off current	I _E = 0 ; V _{CB} = -10V	-	-	-100	nA
h _{FE}	DC current gain	I _C = -14mA;V _{CE} = -10V	20	-	-	
f _T	transition frequency	I _C = -14mA;V _{CE} = -10V f = 300 MHz	-	4.5	-	GHz
G _P	power gain	I _C = -14mA;V _{CE} = -10V f = 500 MHz	-	16	-	dB
NF	noise figure	I _C = -2mA;V _{CE} = -10V; f = 500 MHz	-	2.4	-	dB

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